ROHS COMPLIANT



Vishay General Semiconductor

Surface Mount Schottky Barrier Rectifier



DO-214AC (SMA)

1.5 A

90 V

40 A

0.75 V

150 °C

PRIMARY CHARACTERISTICS

I_{F(AV)}

V_{RRM}

I_{FSM}

 V_{F}

T_{.1} max.

FEATURES

- Low profile package
- · Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- · Very low switching losses
- High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, switching power supplies, freewheeling diodes, oring diode, DC/DC converters and reverse battery protection.

MECHANICAL DATA

Case: DO-214AC (SMA) Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	BYS11-90	UNIT	
Device marking code			BYS109		
Maximum repetitive peak reverse voltage		V _{RRM}	90	V	
Maximum average forward rectified current		I _{F(AV)}	1.5	А	
Peak forward surge current single half sine-wave superimposed on rated load	8.3 ms		40	^	
	10 ms	IFSM	30	— A	
Voltage rate of change (rated V _R)		dV/dt	10 000	V/µs	
Junction and storage temperature range		T _J , T _{STG}	J, T _{STG} - 55 to + 150		

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ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)					
PARAMETER	TEST CONDITIONS		SYMBOL	BYS11-90	UNIT
Maximum instantaneous forward voltage (1)	1.0 A		VF	750	mV
Maximum DC reverse current ⁽¹⁾	V _{RRM}	T _J = 25 °C	- I _R	100	μA
		T _J = 100 °C		1	mA

Note

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYS11-90	UNIT	
Maximum thermal resistance, junction to lead		25	°C/W	
	R _{0JA} ⁽¹⁾	150	°C/W	
Maximum thermal resistance, junction to ambient	R _{0JA} ⁽²⁾	125		
	R _{0JA} ⁽³⁾	100		

Notes

⁽¹⁾ Mounted on epoxy-glass hard tissue

⁽²⁾ Mounted on epoxy-glass hard tissue, 50 mm² 35 µm Cu

⁽³⁾ Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 µm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYS11-90-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYS11-90-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYS11-90HE3/TR (1)	0.064	TR	1800	7" diameter plastic tape and reel	
BYS11-90HE3/TR3 (1)	0.064	TR3	7500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

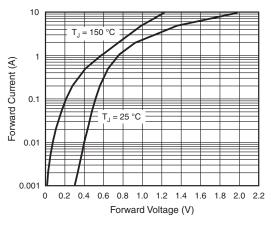


Fig. 1 - Forward Current vs. Forward Voltage

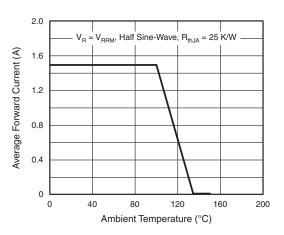


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

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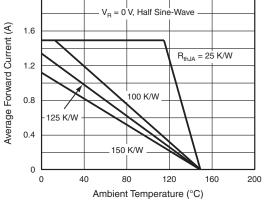


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

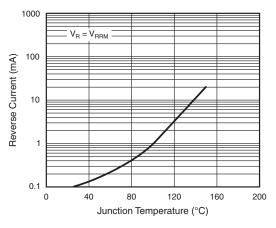
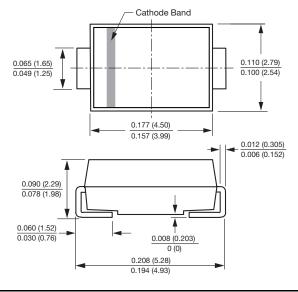
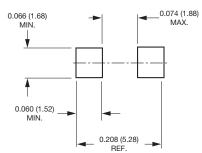


Fig. 4 - Reverse Current vs. Junction Temperature





Mounting Pad Layout



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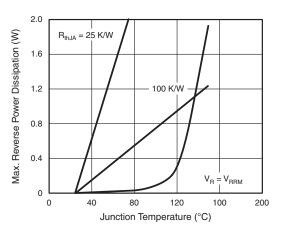


Fig. 5 - Max. Reverse Power Dissipation vs. Junction Temperature

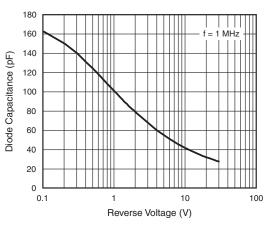


Fig. 6 - Diode Capacitance vs. Reverse Voltage



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